

PNZ335 (PN335)

Silicon planar type

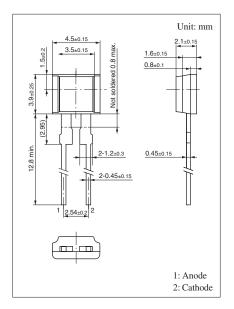
For optical control systems

■ Features

- Flat side-view type package
- High coupling capabillity suitable for plastic fiber
- High quantum efficiency
- High-speed response

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	30	V	
Power dissipation	P_{D}	100	mW	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

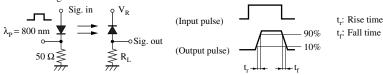


■ Electrical-Optical Characteristics $T_a = 25$ °C ± 3 °C

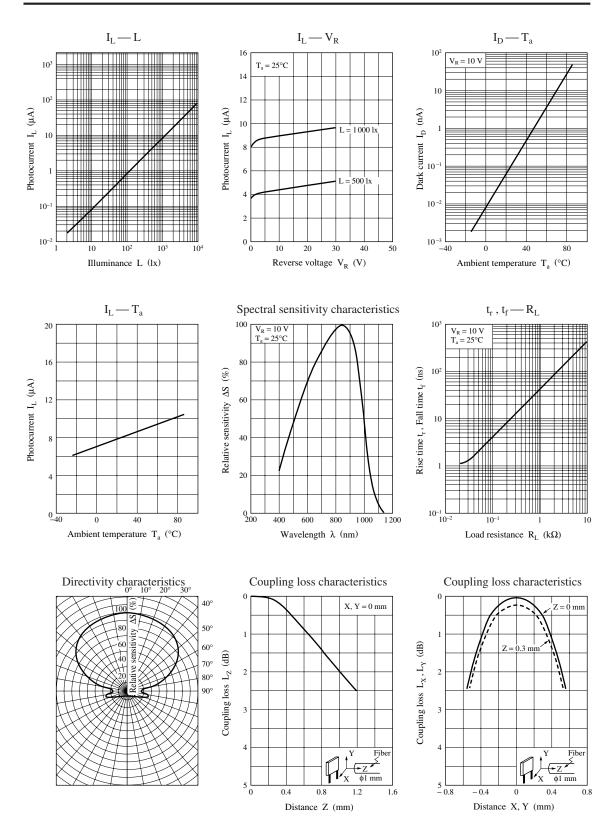
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Dark current	I_D	$V_R = 10 \text{ V}$		0.1	10.0	nA
Photocurrent *1	I_L	$V_R = 10 \text{ V}, L = 1000 \text{ lx}$	5	8		μΑ
Peak emission wavelength	λ_{p}	$V_R = 10 \text{ V}$		850		nm
Rise time *2	t _r	$V_R = 10 \text{ V}, R_L = 50 \Omega$		2		ns
Fall time *2	t _f			2		ns
Terminal capacitance	Ct	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		6		pF
Half-power angle	θ	The angle from which photocurrent becomes 50%		70		0

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- $2. \ Spectral\ sensitivity\ characteristics:\ Sensitivity\ for\ wave\ length\ over\ 400\ nm\ maximum\ sensitivity\ ratio\ is\ 100\%.$
- 3. This device is designed be disregarded radiation.
- 4. *1: Source: Tungsten (color temperature 2856 K)
 - *2: Switching time measurement circuit



Note) The part number in the parenthesis shows conventional part number.



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